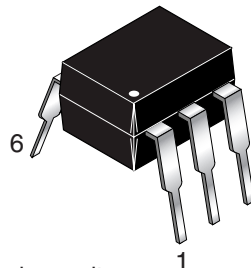


MOC119

DESCRIPTION

The MOC119 device has a gallium arsenide infrared emitting diode coupled to a silicon darlington phototransistor.

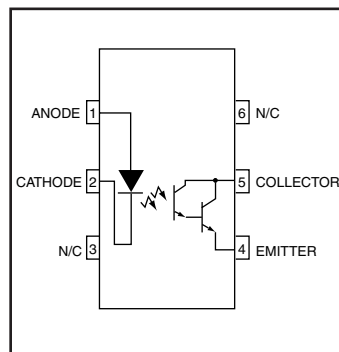


FEATURES

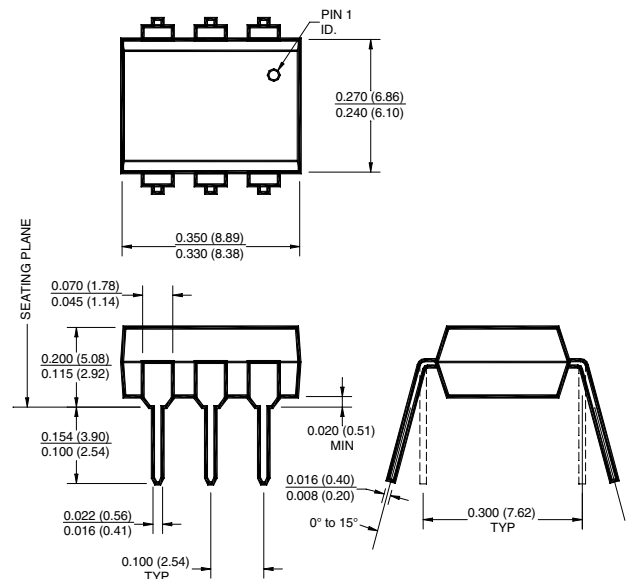
- High current transfer ratio of 300%
- No base connection for improved noise immunity
- Underwriters Laboratory (UL) recognized File# E90700

APPLICATIONS

- Appliances, measuring instruments
- I/O interface for computers
- Programmable controllers
- Portable electronics
- Interfacing and coupling systems of different potentials and impedance
- Solid state relays



PACKAGE DIMENSIONS



NOTE

All dimensions are in inches (millimeters)

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ Unless otherwise specified.)

Parameter	Symbol	Value	Units
TOTAL DEVICE			
Storage Temperature	T _{STG}	-55 to +150	°C
Operating Temperature	T _{OPR}	-55 to +100	°C
Lead Solder Temperature	T _{SOL}	260 for 10 sec	°C
Total Device Power Dissipation @ T _A = 25°C	P _D	250	mW
Derate above 25°C		2.94	mW/°C
Input-Output Isolation Voltage	V _{ISO}	5300	Vac(rms)
EMITTER			
DC/Average Forward Input Current	I _F	60	mA
Reverse Input Voltage	V _R	3	V
LED Power Dissipation @ T _A = 25°C	P _D	120	mW
Derate above 25°C		1.41	mW/°C
DETECTOR			
Collector-Emitter Voltage	V _{CEO}	30	V
Emitter-Collector Voltage	V _{ECO}	7	V
Detector Power Dissipation @ T _A = 25°C	P _D	150	mW
Derate above 25°C		1.76	mW/°C
Continuous Collector Current	I _C	150	mA

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ Unless otherwise specified.)

INDIVIDUAL COMPONENT CHARACTERISTICS

Parameter	Test Conditions	Symbol	Min	Typ**	Max	Unit
EMITTER						
Input Forward Voltage	($I_F = 10\text{ mA}$)	V_F		1.15	1.5	V
Input Capacitance	($V_R = 0$, $f = 1\text{ MHz}$)	C_{IN}		18		pF
Reverse Leakage Current	($V_R = 3.0\text{ V}$)	I_R		0.05	100	μA
DETECTOR						
Collector-Emitter Breakdown Voltage	($I_C = 100\text{ }\mu\text{A}$)	BV_{CEO}	30			V
Emitter-Collector Breakdown Voltage	($I_E = 10\text{ }\mu\text{A}$)	BV_{ECO}	7			V
Collector-Emitter Dark Current	($V_{CE} = 10\text{ V}$)	I_{CEO}			100	nA

TRANSFER CHARACTERISTICS

DC Characteristic	Test Conditions	Symbol	Min	Typ**	Max	Units
Current Transfer Ratio,	($I_F = 10\text{ mA}$, $V_{CE} = 2\text{ V}$)	CTR	30 (300)	45 (450)		mA (%)

TRANSFER CHARACTERISTICS

Characteristic	Test Conditions	Symbol	Min	Typ**	Max	Units
SWITCHING TIMES						
Turn-on Time	(V _{CE} = 10 V, R _L = 100 Ω , I _F = 5 mA)	t _{on}		3.5		μs
Turn-off Time		t _{off}		95		μs

ISOLATION CHARACTERISTICS

Characteristic	Test Conditions	Symbol	Min	Typ**	Max	Units
Input-Output Isolation Voltage	($I_{I-O} \leq 1\text{ }\mu\text{A}$, 1 min.)	V_{ISO}	7500			Vac(pk)
	($I_{I-O} \leq 1\text{ }\mu\text{A}$, 1 min.)		5300			Vac(rms)
Isolation Resistance	($V_{I-O} = 500\text{ VDC}$)	R_{ISO}		10^{11}		Ω
Isolation Capacitance	($V = 0\text{ V}$, $f = 1\text{ MHz}$)	C_{ISO}		0.2		pf
Collector - Emitter Saturation Voltage	($I_C = 10\text{ mA}$, $I_F = 10\text{ mA}$)	$V_{CE(SAT)}$			1	V

Note

** Typical values at $T_A = 25^\circ\text{C}$

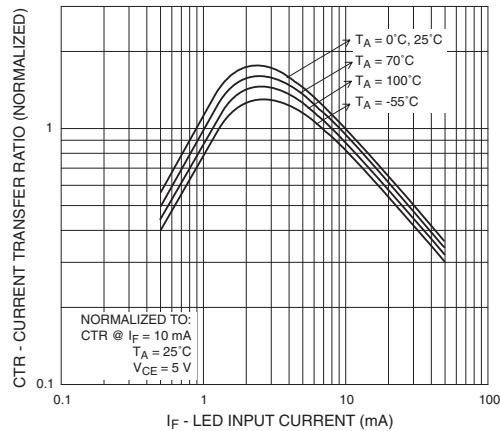


Fig. 1 Output Current vs. Input Current

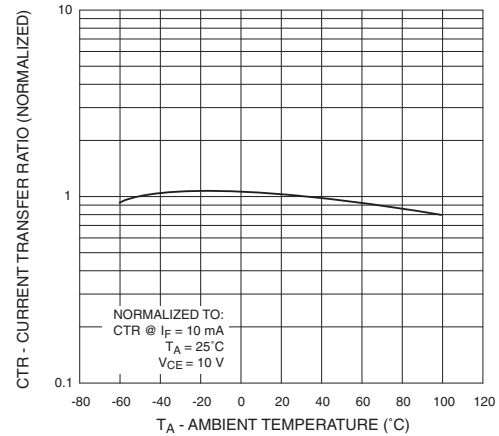


Fig. 2 Current Transfer Ratio vs. Ambient Temperature

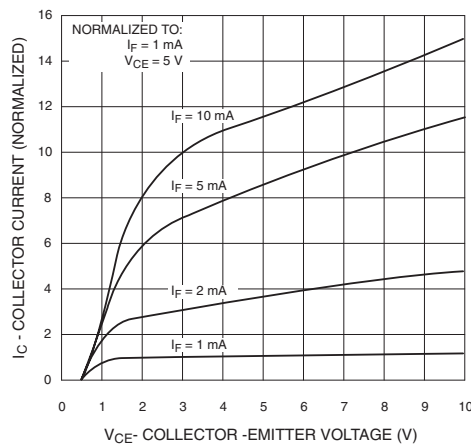


Fig. 3 Collector Current vs. Collector-Emitter Voltage

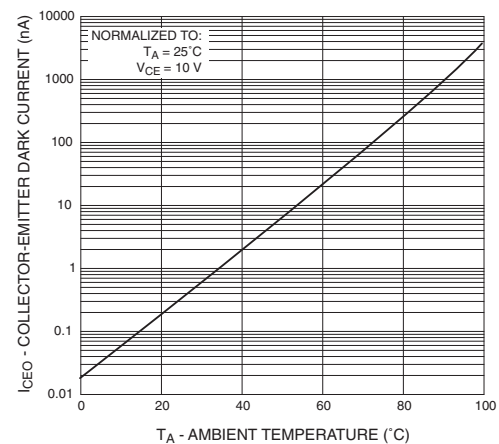


Fig. 4 Dark Current vs. Ambient Temperature

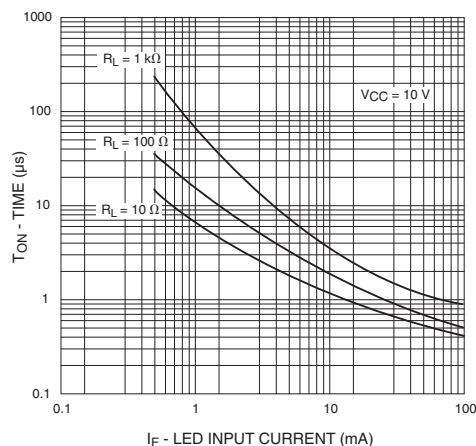


Fig. 5 Turn-On Time vs. Input Current

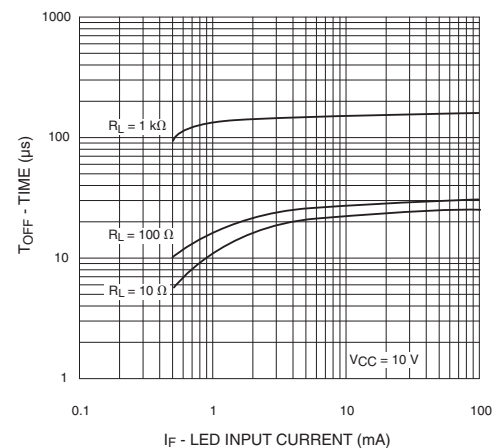
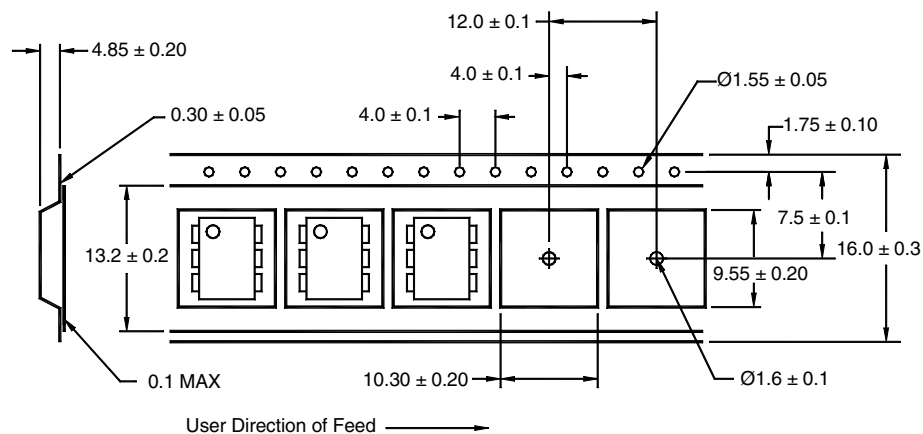


Fig. 6 Turn-Off Time vs. Input Current

ORDERING INFORMATION

Option	Order Entry Identifier	Description
S	.S	Surface Mount Lead Bend
SD	.SD	Surface Mount; Tape and reel
W	.W	0.4" Lead Spacing
300	.300	VDE 0884
300W	.300W	VDE 0884, 0.4" Lead Spacing
3S	.3S	VDE 0884, Surface Mount
3SD	.3SD	VDE 0884, Surface Mount, Tape & Reel

QT Carrier Tape Specifications ("D" Taping Orientation)



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